74HC4017-Q100; 74HCT4017-Q100

Johnson decade counter with 10 decoded outputs

Rev. 2 — 1 July 2020

Product data sheet

1. General description

The 74HC4017-Q100; 74HCT4017-Q100 is a 5-stage Johnson decade counter with 10 decoded outputs (Q0 to Q9), an output from the most significant flip-flop ($\overline{\text{Q5}}$ -9), two clock inputs (CP0 and $\overline{\text{CP1}}$) and an overriding asynchronous master reset input (MR). The counter is advanced by either a LOW-to-HIGH transition at CP0 while $\overline{\text{CP1}}$ is LOW or a HIGH-to-LOW transition at $\overline{\text{CP1}}$ while CP0 is HIGH. When cascading counters, the $\overline{\text{Q5}}$ -9 output, which is LOW while the counter is in states 5, 6, 7, 8 and 9, can be used to drive the CP0 input of the next counter. A HIGH on MR resets the counter to zero (Q0 = $\overline{\text{Q5}}$ -9 = HIGH; Q1 to Q9 = LOW) independent of the clock inputs (CP0 and $\overline{\text{CP1}}$). Automatic code correction of the counter is provided by an internal circuit: following any illegal code the counter returns to a proper counting mode within 11 clock pulses. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 2.0 V to 6.0 V
- CMOS low power dissipation
- High noise immunity
- · Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Complies with JEDEC standards:
 - JESD8C (2.7 V to 3.6 V)
 - JESD7A (2.0 V to 6.0 V)
- Input levels:
 - For 74HC4017-Q100: CMOS level
 - For 74HCT4017-Q100: TTL level
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Multiple package options
- DHVQFN package with Side-Wettable Flanks enabling Automatic Optical Inspection (AOI) of solder joints

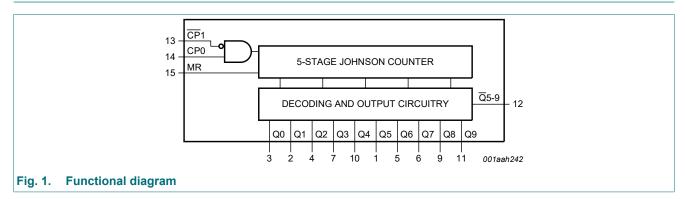


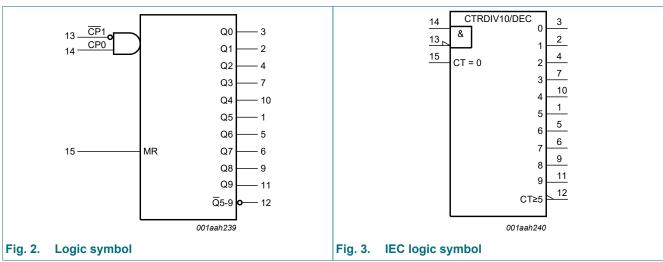
3. Ordering information

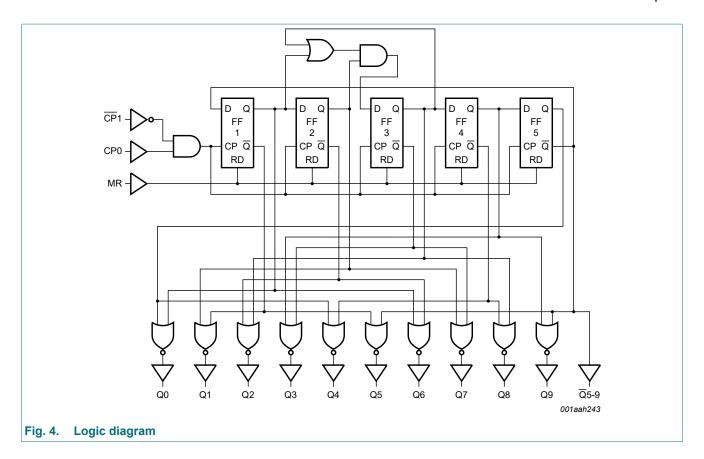
Table 1. Ordering information

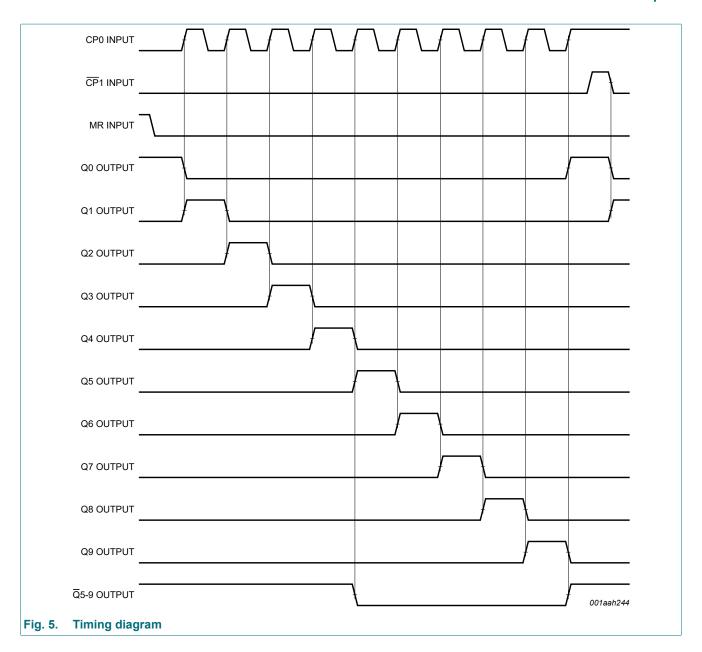
Type number	Package								
	Temperature range	Name	Description	Version					
74HC4017D-Q100	-40 °C to +125 °C	SO16							
74HCT4017D-Q100			body width 3.9 mm						
74HC4017PW-Q100	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1					
74HC4017BQ-Q100	-40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal	SOT763-1					
74HCT4017BQ-Q100			enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 × 3.5 × 0.85 mm						

4. Functional diagram



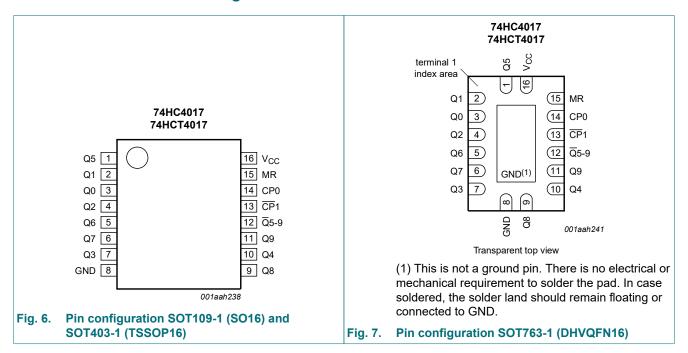






5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
Q0, Q1, Q2, Q3, Q4, Q5, Q6, Q7, Q8, Q9	3, 2, 4, 7, 10, 1, 5, 6, 9, 11	decoded output
GND	8	ground (0 V)
Q5-9	12	carry output (active LOW)
CP1	13	clock input (HIGH-to-LOW edge-triggered)
CP0	14	clock input (LOW-to-HIGH edge-triggered)
MR	15	master reset input (active HIGH)
V _{CC}	16	supply voltage

6. Functional description

Table 3. Function table

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care; \ \uparrow = LOW-to-HIGH \ transition; \ \downarrow = HIGH-to-LOW \ transition;$

MR	CP0	CP1	Operation
Н	Х	Х	$Q0 = \overline{Q}5-9 = HIGH; Q1 \text{ to } Q9 = LOW$
L	Н	↓	counter advances
L	↑	L	counter advances
L	L	Х	no change
L	Х	Н	no change
L	Н	1	no change
L	↓	L	no change

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+7	V
I _{IK}	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$	[1]	-	±20	mA
I _{OK}	output clamping current	V_{O} < -0.5 V or V_{O} > V_{CC} + 0.5 V	[1]	-	±20	mA
Io	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$		-	±25	mA
I _{CC}	supply current			-	50	mA
I _{GND}	ground current			-50	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	T _{amb} = -40 °C to +125 °C	[2]	-	500	mW

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For SOT403-1 (TSSOP16) package: Ptot derates linearly with 8.5 mW/K above 91 °C.

For SOT763-1 (DHVQFN16) package: Ptot derates linearly with 11.2 mW/K above 106 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	74HC4017-Q100			74H0	Q100	Unit	
			Min	Тур	Max	Min	Тур	Max	
V_{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
Δt/ΔV	input transition rise	V _{CC} = 2.0 V	-	-	625	-	-	-	ns/V
	and fall rate	V _{CC} = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V _{CC} = 6.0 V	-	-	83	-	-	-	ns/V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C

^[2] For SOT109-1 (SO16) package: P_{tot} derates linearly with 12.4 mW/K above 110 °C.

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC40	17-Q100		<u>'</u>							
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V _{OH}	HIGH-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = -20 μA; V _{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I _O = -20 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -20 μA; V _{CC} = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I _O = -4.0 mA; V _{CC} = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		I_{O} = -5.2 mA; V_{CC} = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V_{OL}	LOW-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = 20 μA; V _{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 μA; V _{CC} = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA; V _{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I _O = 5.2 mA; V _{CC} = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
I _I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	8.0	-	80	-	160	μΑ
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HCT4	017-Q100						'		<u>'</u>	
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 V$								
	output voltage	Ι _Ο = -20 μΑ	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -4 mA	3.98	4.32	-	3.84	-	3.7	-	V
- OL	LOW-level	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 V$								
	output voltage	Ι _Ο = 20 μΑ	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA	-	0.15	0.26	-	0.33	-	0.4	V
I _I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$; $I_O = 0 \text{ A}$	-	-	8.0	-	80	-	160	μΑ
ΔI _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V}$; other inputs at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V; $I_O = 0 \text{ A}$								
		CP0 input	-	25	90	-	113	-	123	μΑ
		CP1 input	-	40	144	-	180	-	196	μΑ
		MR input	-	50	180	-	225	-	245	μΑ
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

10. Dynamic characteristics

Table 7. Dynamic characteristics

 $GND = 0 \ V; t_r = t_f = 6 \ ns; \ C_L = 50 \ pF; \ see \ Fig. 11.$

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	1
74HC40	17-Q100							1	-	
t _{pd}	propagation delay	CP0 to Qn; CP0 to $\overline{Q}5-9$; [1] see Fig. 8								
		V _{CC} = 2.0 V	-	63	230	-	290	-	345	ns
		V _{CC} = 4.5 V	-	23	46	-	58	-	69	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	20	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	18	39	-	49	-	59	ns
		CP1 to Qn; CP1 to Q5-9; see Fig. 8								
		V _{CC} = 2.0 V	-	61	250	-	315	-	375	ns
		V _{CC} = 4.5 V	-	22	50	-	63	-	75	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	20	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	18	43	-	54	-	64	ns
t _{PHL}		MR to Qn; see Fig. 9								
	propagation delay	V _{CC} = 2.0 V	-	52	230	-	290	-	345	ns
	uelay	V _{CC} = 4.5 V	-	19	46	-	58	-	69	ns
		V _{CC} = 6.0 V	-	15	39	-	49	-	59	ns
t _{PLH}		MR to \overline{Q} 5-9, Q0; see Fig. 9								
	propagation	V _{CC} = 2.0 V	-	55	230	-	290	-	345	ns
	delay	V _{CC} = 4.5 V	-	20	46	-	58	-	69	ns
		V _{CC} = 6.0 V	-	16	39	-	49	-	59	ns
t _t	transition	see <u>Fig. 8</u> [2]								
	time	V _{CC} = 2.0 V	-	19	75	-	95	-	110	ns
		V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
		V _{CC} = 6.0 V	-	6	13	-	16	-	19	ns
t _W	pulse width	CP0 and CP1 (HIGH or LOW); see Fig. 9								
		V _{CC} = 2.0 V	80	17	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	6	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	5	-	17	-	20	-	ns
		MR (HIGH); see Fig. 9								
		V _{CC} = 2.0 V	80	19	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	7	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	6	-	17	-	20	-	ns
t _{su}	set-up time	CP1 to CP0; CP0 to CP1; see Fig. 10								
		V _{CC} = 2.0 V	50	-8	-	65	-	75	-	ns
		V _{CC} = 4.5 V	10	-3	-	13	-	15	-	ns
		V _{CC} = 6.0 V	9	-2	-	11	-	13	-	ns

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
t _h	hold time	CP1 to CP0; CP0 to CP1; see Fig. 10								
		V _{CC} = 2.0 V	50	17	-	65	-	75	-	ns
		V _{CC} = 4.5 V	10	6	-	13	-	15	-	ns
		V _{CC} = 6.0 V	9	5	-	11	-	13	-	ns
t _{rec}	recovery time	MR to CP0 and MR to CP1; see Fig. 9								
		V _{CC} = 2.0 V	5	-17	-	5	-	5	-	ns
		V _{CC} = 4.5 V	5	-6	-	5	-	5	-	ns
		V _{CC} = 6.0 V	5	-5	-	5	-	5	-	ns
f _{max}	maximum	CP0 or CP1; see Fig. 9								
	frequency	V _{CC} = 2.0 V	6.0	23	-	4.8	-	4.0	-	MHz
		V _{CC} = 4.5 V	30	70	-	24	-	20	-	MHz
		V _{CC} = 5.0 V; C _L = 15 pF	-	77	-	-	-	-	-	MHz
		V _{CC} = 6.0 V	25	83	-	28	-	24	-	MHz
C _{PD}	power dissipation capacitance	V_I = GND to V_{CC} ; V_{CC} = 5 V; [3] f_i = 1 MHz	-	35	-	-	-	-	-	pF
74HCT4	017-Q100	<u> </u>								
t _{pd}	propagation delay	CP0 to Qn; CP0 to Q5-9; [1] see Fig. 8								
		V _{CC} = 4.5 V	-	25	46	-	58	-	69	ns
		V _{CC} = 5.0 V; C _L = 15 pF	_	21	-	_	_	_	-	ns
		CP1 to Qn; CP1 to Q5-9; see Fig. 8								
		V _{CC} = 4.5 V	-	25	50	-	63	-	75	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	21	-	-	_	_	_	ns
t _{PHL}	HIGH to LOW	MR to Qn; see Fig. 9								
1112	propagation delay	V _{CC} = 4.5 V	-	22	46	-	58	-	69	ns
t _{PLH}		MR to \(\overline{Q}\)5-9, Q0; see \(\overline{Fig. 9}\)								
	propagation delay	V _{CC} = 4.5 V	-	20	46	-	58	-	69	ns
t _t	transition	see <u>Fig. 8</u> [2]								
	time	V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
t _W	pulse width	CP0 and CP1 (HIGH or LOW); see Fig. 9								
		V _{CC} = 4.5 V	16	7	-	20	-	24	-	ns
		MR (HIGH); see Fig. 9								
		V _{CC} = 4.5 V	16	4	-	20	-	24	-	ns
t _{su}	set-up time	CP1 to CP0; CP0 to CP1; see Fig. 10								
		V _{CC} = 4.5 V	10	-3	-	13	-	15	-	ns
t _h	hold time	CP1 to CP0; CP0 to CP1; see Fig. 10								
		V _{CC} = 4.5 V	10	6	_	13	_	15	_	ns

Symbol	Parameter	Conditions		25 °C			-40 °C to +85 °C		-40 °C to +125 °C	
			Min	Тур	Max	Min	Max	Min	Max	
t _{rec}	recovery time	MR to CP0 and MR to CP1; see <u>Fig. 9</u>								
		V _{CC} = 4.5 V	5	-5	-	5	-	5	-	ns
f _{max}	maximum	CP0 or CP1; see Fig. 9								
	frequency	V _{CC} = 4.5 V	30	61	-	24	-	20	-	MHz
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	67	-	-	-	-	-	MHz
C _{PD}	power dissipation capacitance	$V_I = GND \text{ to } V_{CC} - 1.5 \text{ V};$ [3] $V_{CC} = 5 \text{ V}; f_i = 1 \text{ MHz}$	-	36	-	-	-	-	-	pF

- [1] t_{pd} is the same as t_{PHL} and t_{PLH} .
- t_t is the same as t_{THL} and t_{TLH} . C_{PD} is used to determine the dynamic power dissipation (P_D in μW):

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

f_i = input frequency in MHz;

f_o = output frequency in MHz;

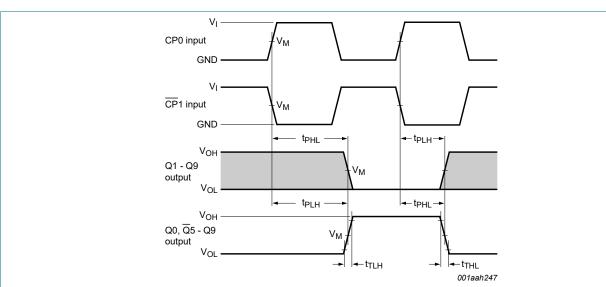
C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs.}$

10.1. Waveforms and test circuit



Measurement points are given in Table 8.

V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Conditions: $\overline{\text{CP}}1$ = LOW while CP0 is triggered on a LOW-to-HIGH transition and CP0 = HIGH, while $\overline{\text{CP}}1$ is triggered on a HIGH-to-LOW transition.

Waveforms showing the propagation delays for CP0, $\overline{\text{CP1}}$ to Qn, $\overline{\text{Q}}$ 5-9 outputs and the output transition Fig. 8. times

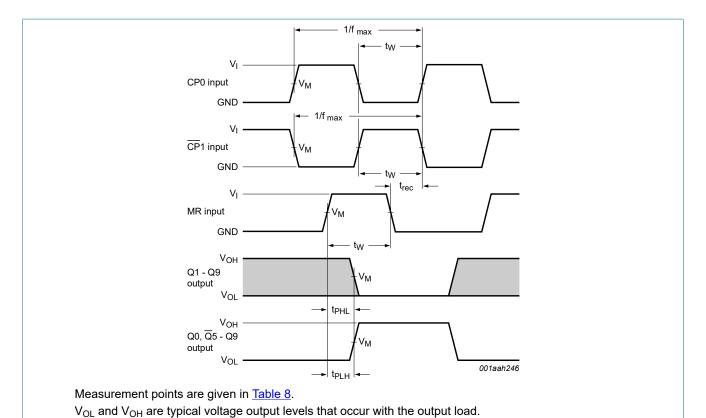
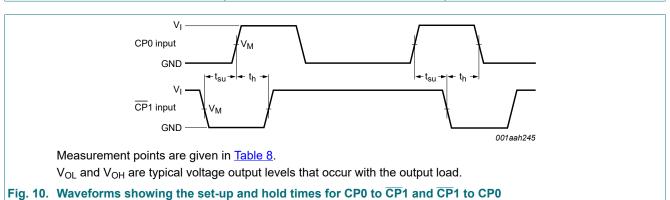
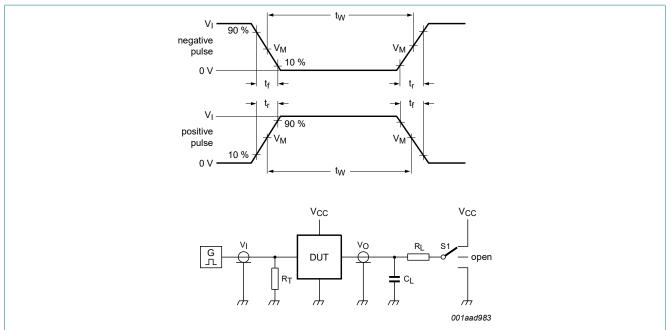


Fig. 9. Waveforms showing the minimum pulse width for CP0, $\overline{\text{CP1}}$ and MR input; the maximum frequency for CP0 and $\overline{\text{CP1}}$ input; the recovery time for MR and the MR input to Qn and $\overline{\text{Q5-9}}$ output propagation delays

Table 8. Measurement points

Туре	Input	Output
	V _M	V _M
74HC4017-Q100	0.5 x V _{CC}	0.5 x V _{CC}
74HCT4017-Q100	1.3 V	1.3 V





Test data is given in Table 9.

Definitions test circuit:

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

C_L = Load capacitance including jig and probe capacitance.

 R_{I} = Load resistance.

S1 = Test selection switch.

Fig. 11. Test circuit for measuring switching times

Table 9. Test data

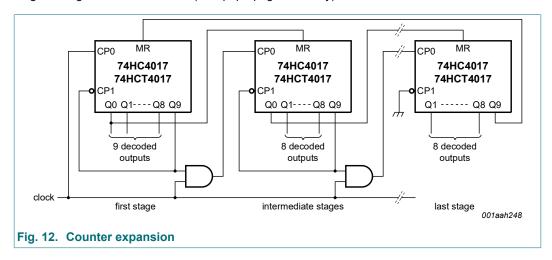
Туре	Input		Load		S1 position		
	V _I	t _r , t _f	CL	R_L	t _{PHL} , t _{PLH}	t _{PZH} , t _{PHZ}	t_{PZL}, t_{PLZ}
74HC4017-Q100	V _{CC}	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}
74HCT4017-Q100	3 V	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}

11. Application information

Some examples of applications for the 74HC4017-Q100; 74HCT4017-Q100 are:

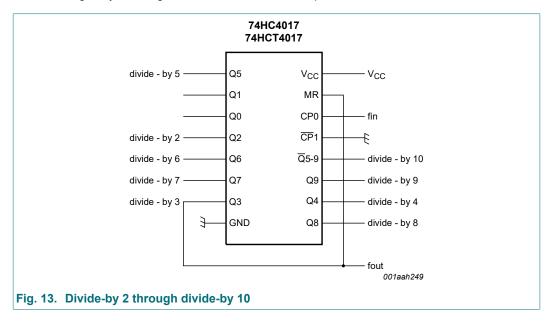
- Decade counter with decimal decoding
- 1 out of n decoding counter (when cascaded)
- · Sequential controller
- Time

Fig. 12 shows a technique for extending the number of decoded output states for the 74HC4017-Q100; 74HCT4017-Q100. Decoded outputs are sequential within each stage and from stage to stage, with no dead time (except propagation delay).



Remark: It is essential not to enable the counter on $\overline{CP}1$ when CP0 is HIGH, or on CP0 when $\overline{CP}1$ is LOW, as this would cause an extra count.

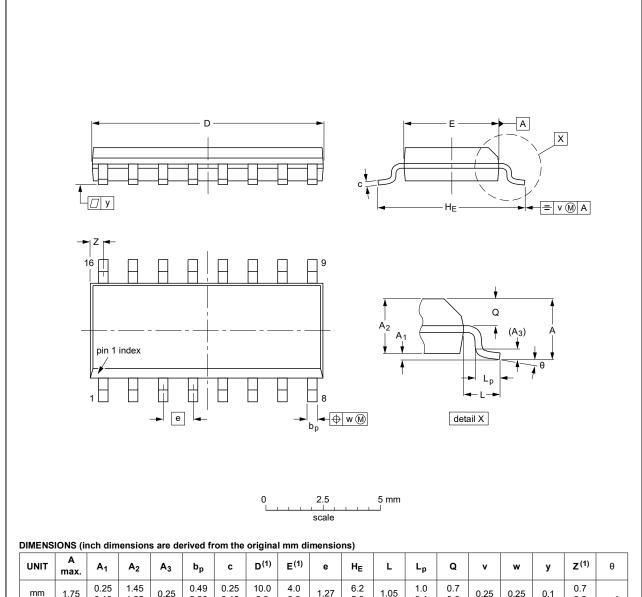
Fig. 13 shows an example of a divide-by 2 through divide-by 10 circuit using one 74HC4017-Q100; 74HCT4017-Q100. Since the 74HC4017-Q100; 74HCT4017-Q100 has an asynchronous reset, the output pulse widths are narrow (minimum expected pulse width is 6 ns). The output pulse widths can be enlarged by inserting an RC network at the MR input.



12. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

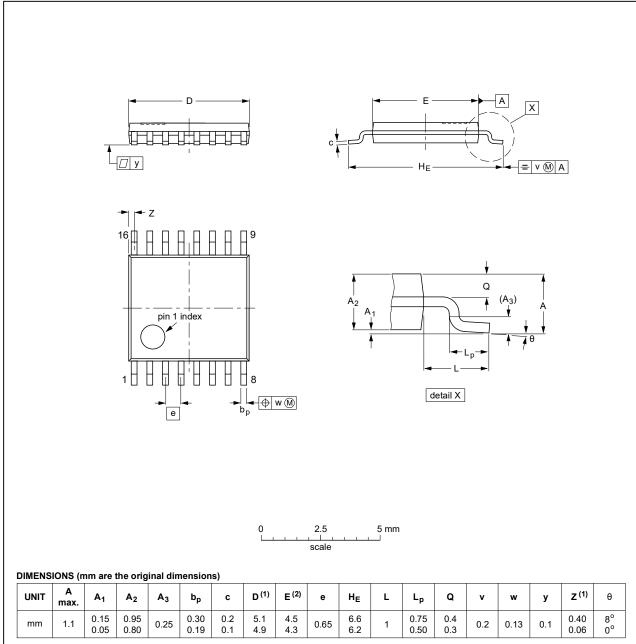
OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT109-1	076E07	MS-012				99-12-27 03-02-19	

Fig. 14. Package outline SOT109-1 (SO16)

Product data sheet

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT403-1		MO-153				99-12-27 03-02-18	

Fig. 15. Package outline SOT403-1 (TSSOP16)

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

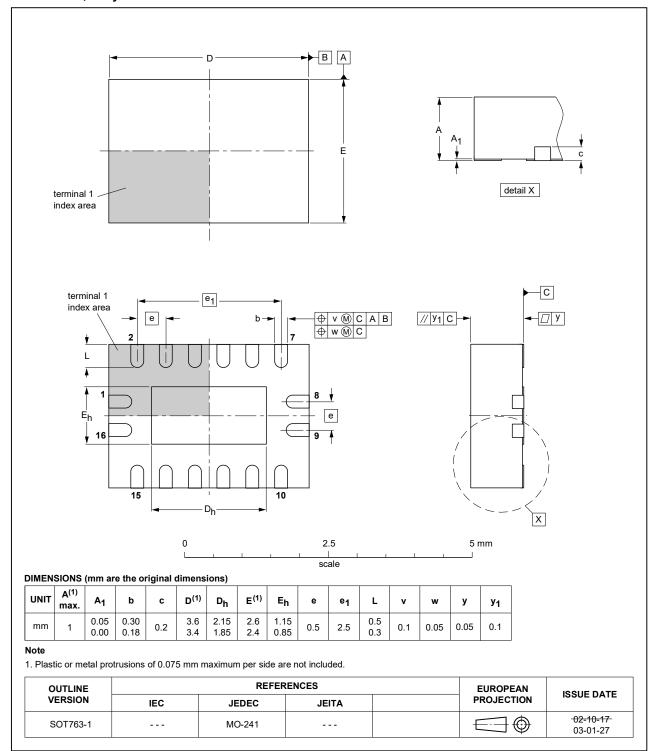


Fig. 16. Package outline SOT763-1 (DHVQFN16)

13. Abbreviations

Table 10. Abbreviations

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MIL	Military
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT4017_Q100 v.2	20200701	Product data sheet	-	74HC_HCT4017_Q100 v.1
Modifications:	of Nexperia. • Legal texts have • Section 1 and S	e been adapted to the ne ection 2 updated. g values for P _{tot} total po	ew company name v	
74HC_HCT4017_Q100 v.1	20140324	Product data sheet	-	-

equipment, nor in applications where failure or malfunction of an Nexperia

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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Johnson decade counter with 10 decoded outputs

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